

## Normally – OFF Silicon Carbide Super Junction Transistor

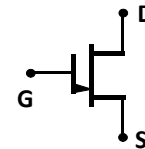
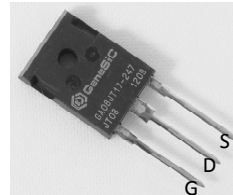
|              |   |                |
|--------------|---|----------------|
| $V_{DS}$     | = | 1700 V         |
| $V_{DS(ON)}$ | = | 2.0 V          |
| $I_D$        | = | 8 A            |
| $R_{DS(ON)}$ | = | 250 m $\Omega$ |

### Features

- 175 °C maximum operating temperature
- Temperature independent switching performance
- Gate oxide free SiC switch
- Suitable for connecting an anti-parallel diode
- Positive temperature coefficient for easy paralleling
- Low gate charge
- Low intrinsic capacitance

### Package

- RoHS Compliant



**TO-247AB**

### Advantages

- Low switching losses
- Higher efficiency
- High temperature operation
- High short circuit withstand capability

### Applications

- Down Hole Oil Drilling, Geothermal Instrumentation
- Hybrid Electric Vehicles (HEV)
- Solar Inverters
- Switched-Mode Power Supply (SMPS)
- Power Factor Correction (PFC)
- Induction Heating
- Uninterruptible Power Supply (UPS)
- Motor Drives

### Maximum Ratings unless otherwise specified

| Parameter                      | Symbol    | Conditions                | Values     | Unit       |
|--------------------------------|-----------|---------------------------|------------|------------|
| Drain – Source Voltage         | $V_{DS}$  | $V_{GS} = 0 V$            | 1700       | V          |
| Continuous Drain Current       | $I_D$     | $T_{C,MAX} = 90 ^\circ C$ | 8          | A          |
| Gate Peak Current              | $I_{GM}$  |                           | 5          | A          |
| Reverse Gate – Source Voltage  | $V_{SG}$  |                           | 60         | V          |
| Reverse Drain – Source Voltage | $V_{SD}$  |                           | 50         | V          |
| Power Dissipation              | $P_{tot}$ | $T_c = 25 ^\circ C$       | 16         | W          |
| Storage Temperature            | $T_{stg}$ |                           | -55 to 175 | $^\circ C$ |

### Electrical Characteristics at $T_j = 175 ^\circ C$ , unless otherwise specified

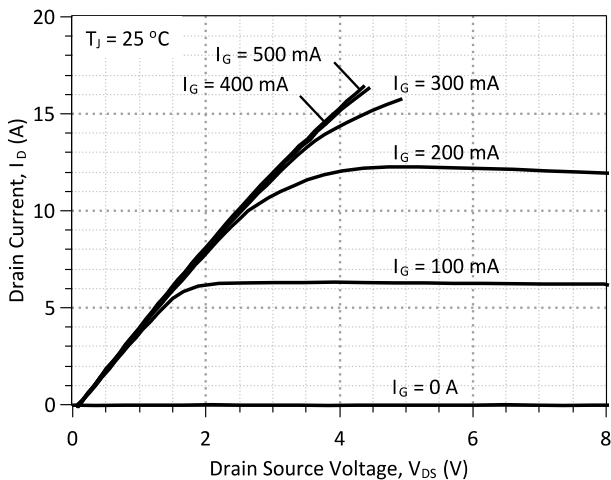
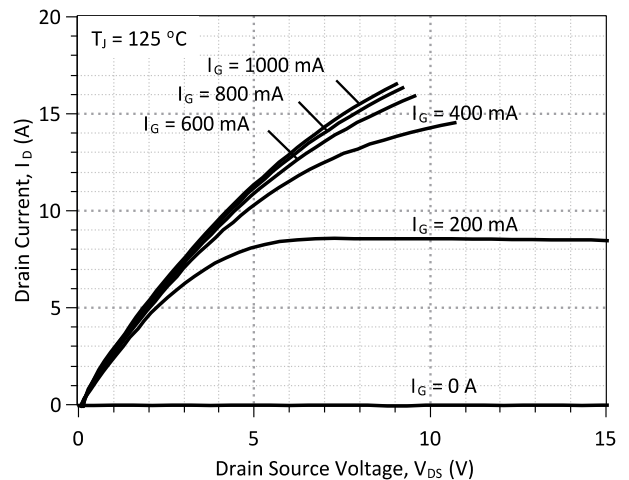
| Parameter                    | Symbol        | Conditions  | Values |            |      | Unit       |
|------------------------------|---------------|---|--------|------------|------|------------|
|                              |               |   | min.   | typ.       | max. |            |
| <b>On Characteristics</b>    |               |   |        |            |      |            |
| Drain – Source On Voltage    | $V_{DS(ON)}$  | $I_D = 8 A, I_G = 500 mA, T_j = 25 ^\circ C$                            |        | 2.0        |      | V          |
|                              |               | $I_D = 8 A, I_G = 1000 mA, T_j = 125 ^\circ C$                          |        | 3.3        |      |            |
|                              |               | $I_D = 8 A, I_G = 1000 mA, T_j = 175 ^\circ C$                          |        | 4.5        |      |            |
| Drain – Source On Resistance | $R_{DS(ON)}$  | $I_D = 8 A, I_G = 500 mA, T_j = 25 ^\circ C$                            |        | 250        |      | m $\Omega$ |
|                              |               | $I_D = 8 A, I_G = 1000 mA, T_j = 125 ^\circ C$                          |        | 400        |      |            |
|                              |               | $I_D = 8 A, I_G = 1000 mA, T_j = 175 ^\circ C$                          |        | 550        |      |            |
| Gate Forward Voltage         | $V_{GS(FWD)}$ | $I_G = 500 mA, T_j = 25 ^\circ C$<br>$I_G = 500 mA, T_j = 175 ^\circ C$ |        | 3.0<br>2.8 |      | V          |
| DC Current Gain              | $\beta$       | $V_{DS} = 5 V, I_D = 8 A, T_j = 25 ^\circ C$                            |        | 65         |      |            |
|                              |               | $V_{DS} = 5 V, I_D = 8 A, T_j = 175 ^\circ C$                           |        | 40         |      |            |
| <b>Off Characteristics</b>   |               |   |        |            |      |            |
| Drain Leakage Current        | $I_{DSS}$     | $V_R = 1700 V, V_{GS} = 0 V, T_j = 25 ^\circ C$                         |        | 0.1        |      | $\mu A$    |
|                              |               | $V_R = 1700 V, V_{GS} = 0 V, T_j = 125 ^\circ C$                        |        | 0.5        |      |            |
|                              |               | $V_R = 1700 V, V_{GS} = 0 V, T_j = 175 ^\circ C$                        |        | 2.0        |      |            |

**Electrical Characteristics at  $T_j = 175\text{ }^\circ\text{C}$ , unless otherwise specified**

| Parameter                        | Symbol       | Conditions   | Values |      |      | Unit          |
|----------------------------------|--------------|--|--------|------|------|---------------|
|                                  |              |  | min.   | typ. | max. |               |
| <b>Switching Characteristics</b> |              |  |        |      |      |               |
| Turn On Delay Time               | $t_{d(on)}$  | $V_{DD} = 1100\text{ V}$ , $I_D = 8\text{ A}$ ,<br>$R_{G(on)} = R_{G(off)} = 44\ \Omega$ ,<br>$V_{GS} = -8/15\text{ V}$ , $L = 1.1\text{ mH}$ ,<br>FWD = GB05SLT12,<br>$T_j = 25\text{ }^\circ\text{C}$  |        | 35   |      | ns            |
| Rise Time                        | $t_r$        |  |        | 37   |      | ns            |
| Turn Off Delay Time              | $t_{d(off)}$ |  |        | 45   |      | ns            |
| Fall Time                        | $t_f$        |  |        | 38   |      | ns            |
| Turn-On Energy Per Pulse         | $E_{on}$     |  |        |      | 678  |               |
| Turn-Off Energy Per Pulse        | $E_{off}$    | Refer to Figure 11 for gate current waveform   |        | 24   |      | $\mu\text{J}$ |
| Total Switching Energy           | $E_{ts}$     |  |        | 702  |      | $\mu\text{J}$ |
| Turn On Delay Time               | $t_{d(on)}$  | $V_{DD} = 1100\text{ V}$ , $I_D = 8\text{ A}$ ,<br>$R_{G(on)} = R_{G(off)} = 44\ \Omega$ ,<br>$V_{GS} = -8/15\text{ V}$ , $L = 1.1\text{ mH}$ ,<br>FWD = GB05SLT12,<br>$T_j = 175\text{ }^\circ\text{C}$ |        | 28   |      |               |
| Rise Time                        | $t_r$        |  |        | 25   |      | ns            |
| Turn Off Delay Time              | $t_{d(off)}$ |  |        | 44   |      | ns            |
| Fall Time                        | $t_f$        |  |        | 33   |      | ns            |
| Turn-On Energy Per Pulse         | $E_{on}$     |  |        |      | 495  |               |
| Turn-Off Energy Per Pulse        | $E_{off}$    | Refer to Figure 11 for gate current waveform   |        | 26   |      | $\mu\text{J}$ |
| Total Switching Energy           | $E_{ts}$     |  |        | 521  |      | $\mu\text{J}$ |

**Thermal Characteristics**

|                                     |            |      |                    |
|-------------------------------------|------------|------|--------------------|
| Thermal resistance, junction - case | $R_{thJC}$ | 1.03 | $^\circ\text{C/W}$ |
|-------------------------------------|------------|------|--------------------|


**Figure 1: Typical Output Characteristics at 25 °C**

**Figure 2: Typical Output Characteristics at 125 °C**

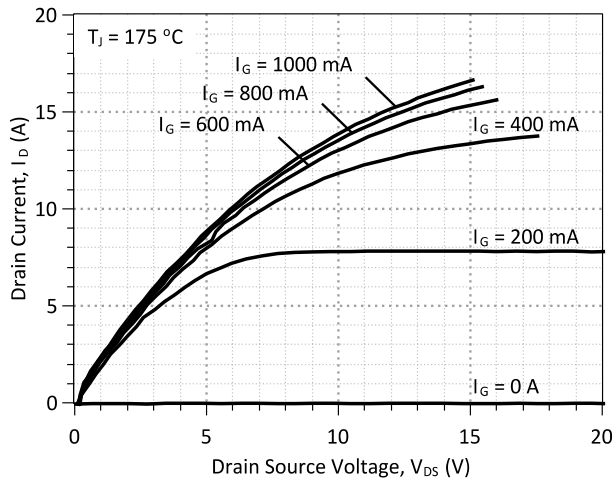


Figure 3: Typical Output Characteristics at 175 °C

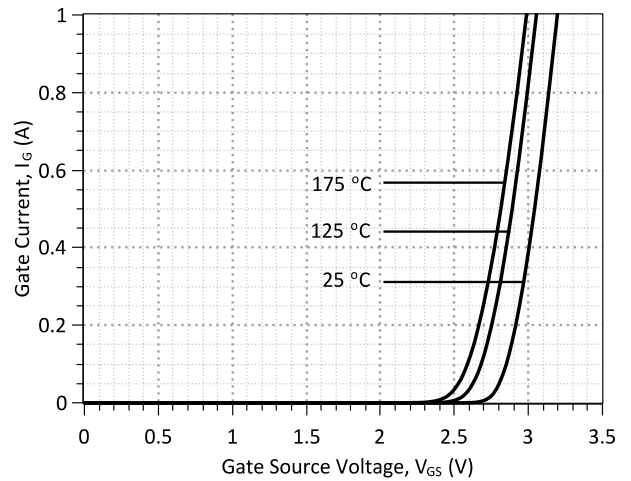


Figure 4: Typical Gate Source I-V Characteristics vs. Temperature

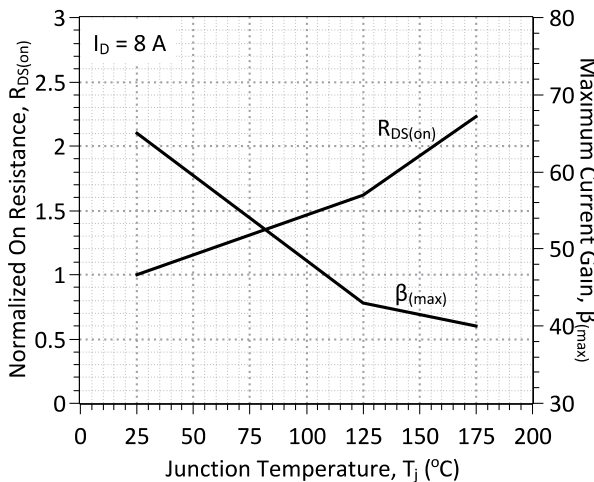


Figure 5: Normalized On-Resistance and Current Gain vs. Temperature

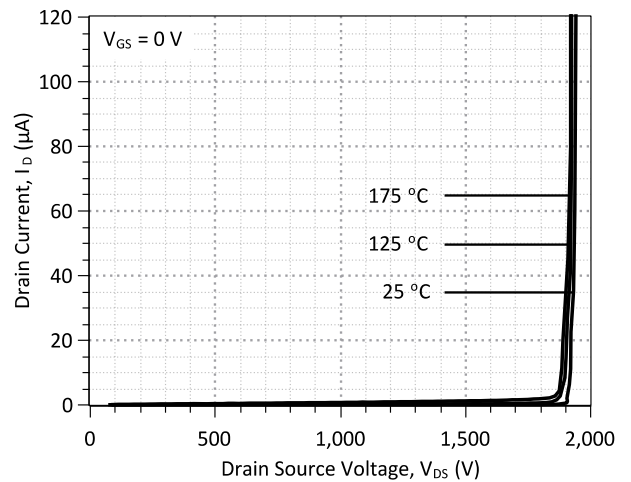


Figure 6: Typical Blocking Characteristics

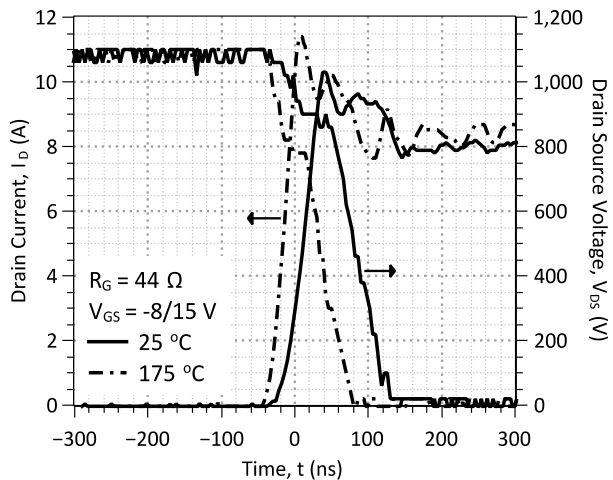


Figure 7: Typical Hard-switched Turn On Waveforms

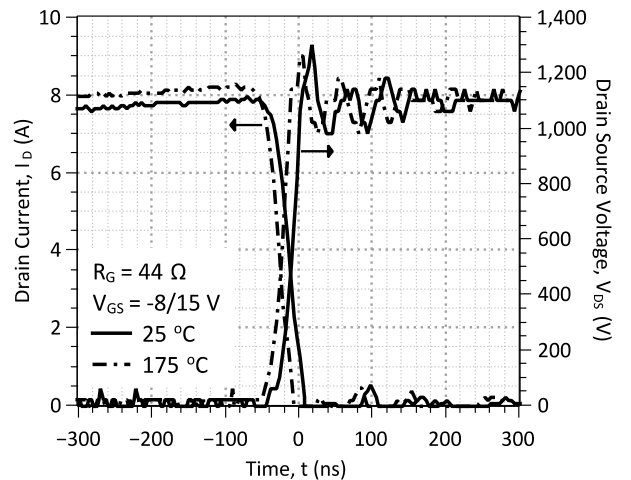
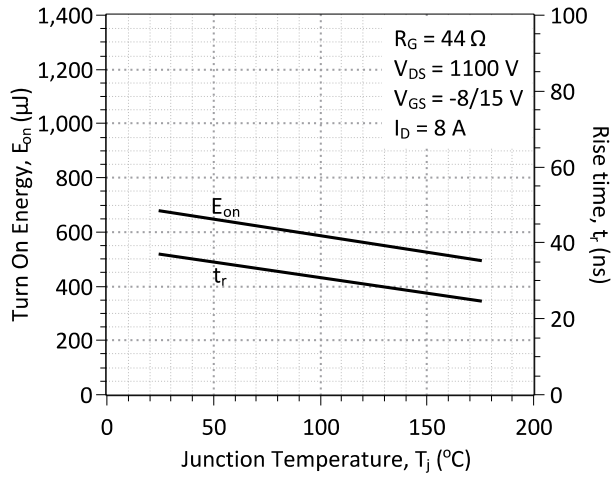
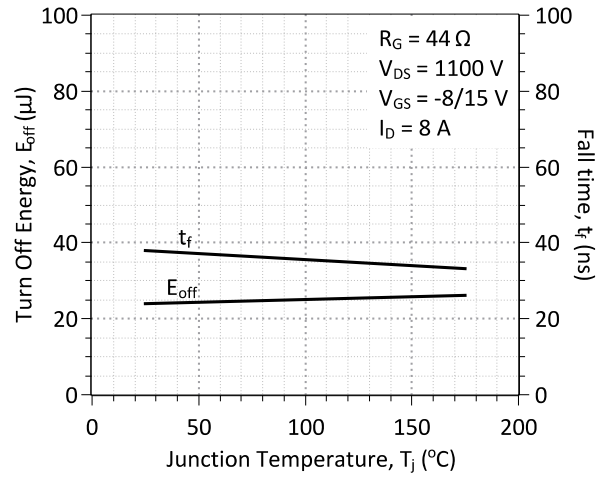


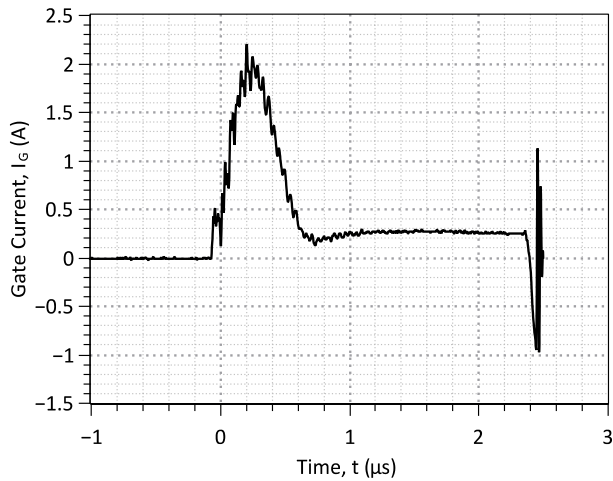
Figure 8: Typical Hard-switched Turn Off Waveforms



**Figure 9: Typical Turn On Energy Losses and Switching Times vs. Temperature**



**Figure 10: Typical Turn Off Energy Losses and Switching Times vs. Temperature**



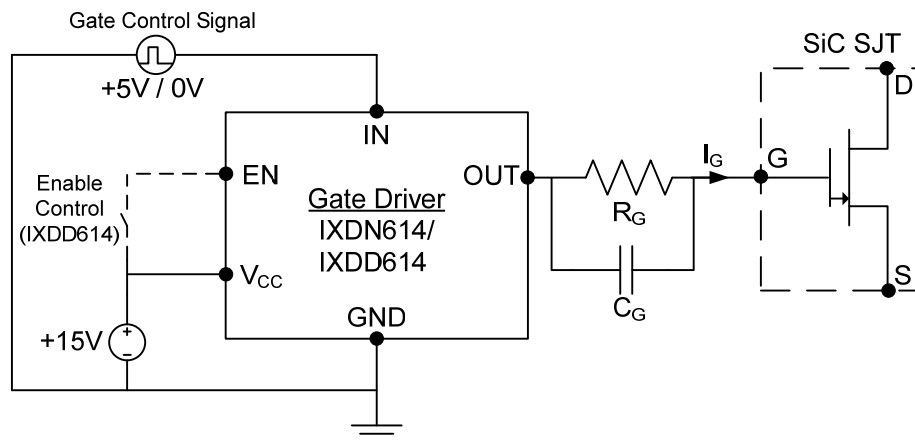
**Figure 11: Typical Gate Current Waveform**

**Gate Drive Technique (Option #1)**

To drive the GA08JT17-247 with the lowest gate drive losses, a custom-designed, dual voltage source gate drive configuration is recommended [for example, see Figure 5(a) in J. Rabkowski et al. IEEE Trans. Power Electronics 27(5), 2633-2642 (2012)]. More details on using this optimized gate drive technique will be made available shortly. An effective simple alternative for ultra-fast switching of the GA08JT17-247 is available below.

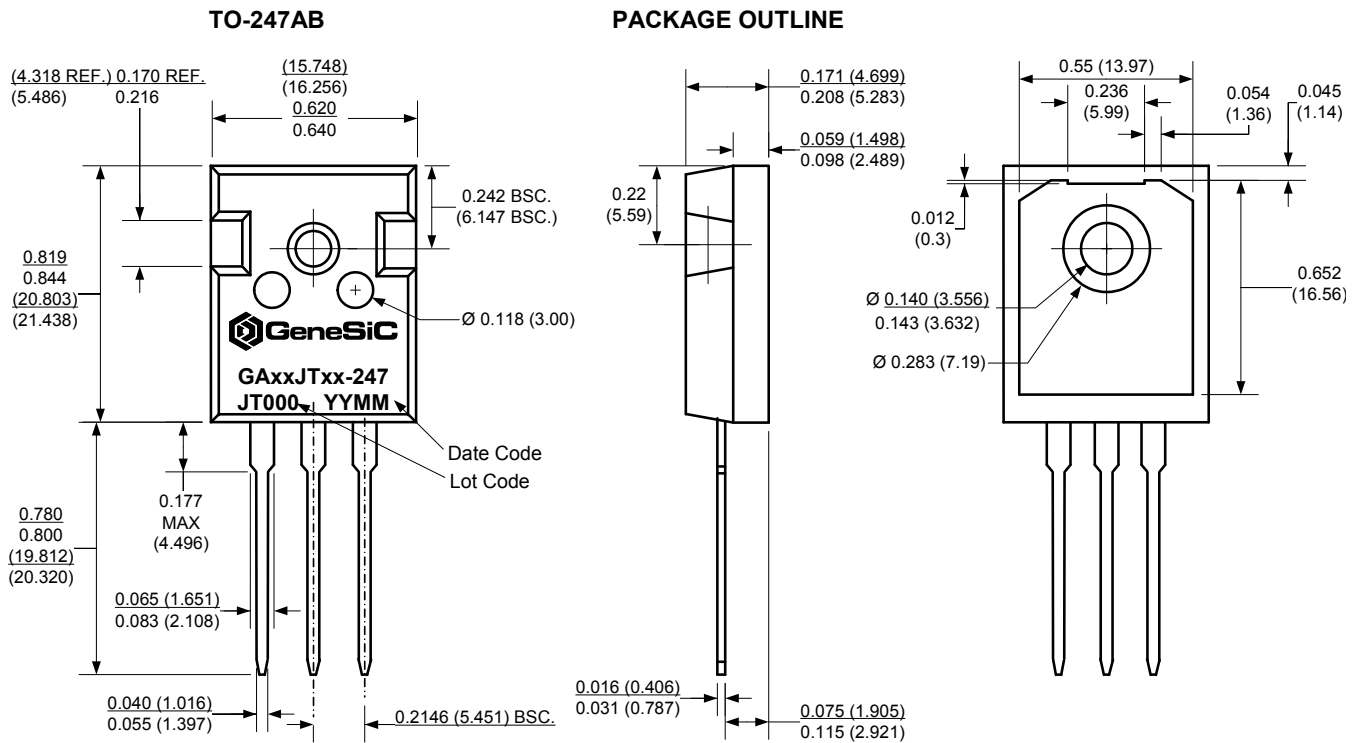
**Gate Drive Technique (Option #2)**

The GA08JT17-247 can be effectively driven using the IXYS IXDN614 / IXDD614 non-inverting gate driver IC or a comparable product. A typical gate driver configuration along with component values using this driver is offered below. Additional information is available from the manufacturer at [www.ixys.com](http://www.ixys.com).


**Figure 14: Recommended Gate Diver Configuration (Option #2)**

| Parameter                                 | Symbol    | Conditions                  | Values         |                    |                    | Unit     |
|---|-----------|-----------------------------|----------------|--------------------|--------------------|----------|
|   |           |                             | min.           | typ.               | max.               |          |
| <b>Gate Driver Pins (IXDD614/IXDN614)</b> |           |                             |                |                    |                    |          |
| Supply Voltage                            | $V_{CC}$  |                             | -0.3           | 15                 | 40                 | V        |
| Gate Control Input Signal, Low            | IN        |                             | -5.0           | 0                  | 0.8                | V        |
| Gate Control Input Signal, High           | IN        |                             | 3.0            | 5.0                | $V_{CC}+0.3$       | V        |
| Enable, Low                               | EN        | IXDD614 Only                |                |                    | $1/3 \cdot V_{CC}$ | V        |
| Enable, High                              | EN        | IXDD614 Only                |                | $2/3 \cdot V_{CC}$ |                    | V        |
| Output Voltage, Low                       | $V_{OUT}$ |                             |                |                    | 0.025              | V        |
| Output Voltage, High                      | $V_{OUT}$ |                             | $V_{CC}-0.025$ |                    |                    | V        |
| Output Current, Peak                      | $I_{OUT}$ | Package Limited             |                | 4.5                | 14                 | A        |
| Output Current, Continuous                | $I_{OUT}$ |                             |                | 0.5                | 4.0                | A        |
| <b>Passive Gate Components</b>            |           |                             |                |                    |                    |          |
| Gate Resistance                           | $R_G$     | $I_G \approx 0.5 \text{ A}$ | 5              | 22                 |                    | $\Omega$ |
| Gate Capacitance                          | $C_G$     | $I_G \approx 0.5 \text{ A}$ |                | 100                |                    | nF       |

**Package Dimensions:**



**NOTE**

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

| Revision History |          |                      |            |
|------------------|----------|----------------------|------------|
| Date             | Revision | Comments             | Supersedes |
| 2013/02/21       | 1        | Switching Data Added |            |
| 2012/12/03       | 0        | Initial release      |            |
|                  |          |                      |            |

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